

SMPS MOSFET

IRFBL17N50L

HEXFET® Power MOSFET

Applications

- Telecom and Data-Com off-Line SMPS
- Motor Control
- Uninterruptible Power Supply

Benefits

- Low On-Resistance
- High Speed Switching
- Low Gate Drive Current Due to Improved Gate Charge Characteristics
- Built in Fast Recovery Diode
- Improved Avalanche Ruggedness and Dynamic dv/dt, Fully Characterized Avalanche Voltage and Current

V_{DS}	$R_{DS(on)}$	I_D
500V	0.28Ω	17A



Absolute Maximum Ratings

	Parameter	Max.	Units
I_D @ $T_C = 25^\circ\text{C}$	Continuous Drain Current, V_{GS} @ 10V	17	A
I_D @ $T_C = 100^\circ\text{C}$	Continuous Drain Current, V_{GS} @ 10V	10	
I_{DM}	Pulsed Drain Current ①	68	
P_D @ $T_C = 25^\circ\text{C}$	Power Dissipation	200	W
	Linear Derating Factor	1.6	W/°C
V_{GS}	Gate-to-Source Voltage	± 30	V
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 150	°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	260	

Diode Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
I _S	Continuous Source Current (Body Diode)	—	—	17	A	MOSFET symbol showing the integral reverse p-n junction diode. 
I _{SM}	Pulsed Source Current (Body Diode) ①	—	—	68		
V _{SD}	Diode Forward Voltage	—	—	1.5	V	T _J = 25°C, I _S = 17A, V _{GS} = 0V ④
t _{rr}	Reverse Recovery Time	—	180	—	ns	T _J = 125°C, I _F = 17A di/dt = 100A/μs ④
Q _{rr}	Reverse RecoveryCharge	—	420	—	nC	
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L _S +L _D)				

Typical SMPS Topologies

- Zero Voltage Switching Full and Half Bridge Circuits

IRFB17N50L

PROVISIONAL

International
IR Rectifier

Static @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	500	—	—	V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	0.55	—	V/°C	Reference to 25°C , $I_D = 1mA$ ⑥
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	—	0.28	Ω	$V_{GS} = 10V, I_D = 10A$ ④
$V_{GS(th)}$	Gate Threshold Voltage	3.5	—	5.5	V	$V_{DS} = V_{GS}, I_D = 250\mu A$
I_{DSS}	Drain-to-Source Leakage Current	—	—	50	μA	$V_{DS} = 500V, V_{GS} = 0V$
		—	—	2.0	mA	$V_{DS} = 400V, V_{GS} = 0V, T_J = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{GS} = 30V$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{GS} = -30V$

Dynamic @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
g_{fs}	Forward Transconductance	7.5	—	—	S	$V_{DS} = 50V, I_D = 10A$
Q_g	Total Gate Charge	—	—	110	nC	$I_D = 17A$
Q_{gs}	Gate-to-Source Charge	—	—	40		$V_{DS} = 400V$
Q_{gd}	Gate-to-Drain ("Miller") Charge	—	—	50		$V_{GS} = 10V$, ④
$t_{d(on)}$	Turn-On Delay Time	—	20	—	ns	$V_{DD} = 250V$
t_r	Rise Time	—	55	—		$I_D = 17A$
$t_{d(off)}$	Turn-Off Delay Time	—	45	—		$R_G = 9.0\Omega$
t_f	Fall Time	—	45	—		$V_{GS} = 10V$, ④
C_{iss}	Input Capacitance	—	3000	—	pF	$V_{GS} = 0V$
C_{oss}	Output Capacitance	—	300	—		$V_{DS} = 25V$
C_{rss}	Reverse Transfer Capacitance	—	20	—		$f = 1.0MHz$

Avalanche Characteristics

Symbol	Parameter	Typ.	Max.	Units
E_{AS}	Single Pulse Avalanche Energy②	—	430	mJ
I_{AR}	Avalanche Current①	—	17	A
E_{AR}	Repetitive Avalanche Energy①	—	20	mJ

Thermal Resistance

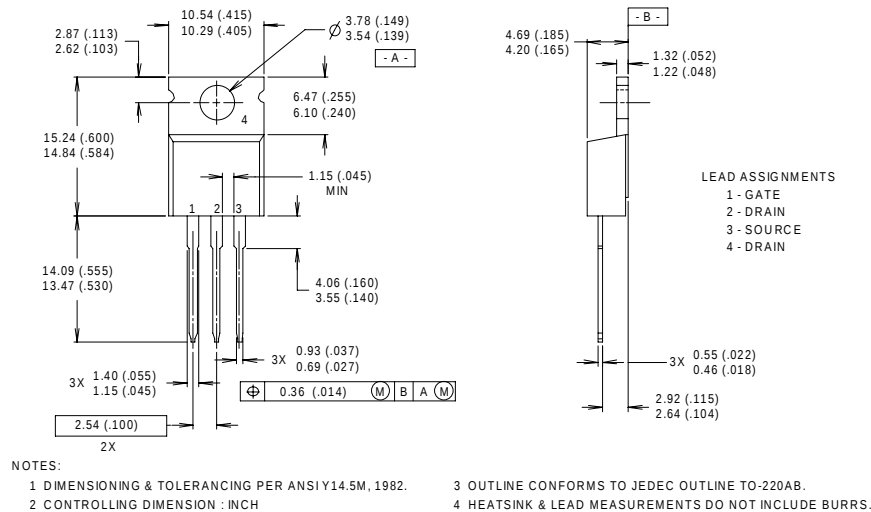
Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	0.63	°C/W
$R_{\theta JA}$	Junction-to-Ambient (PCB Mounted, steady-state)	—	40	

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. ④ Pulse width $\leq 400\mu s$; duty cycle $\leq 2\%$.
- ② Starting $T_J = 25^\circ\text{C}$, $L = 5.0mH$, $R_G = 25\Omega$, $I_{AS} = 17A$,
- ③ $I_{SD} \leq 17A$, $di/dt \leq TBDA/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 150^\circ\text{C}$

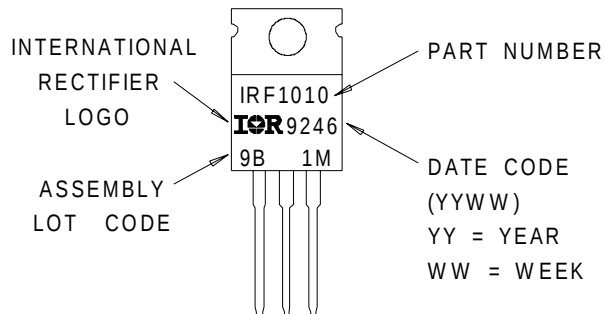
TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



TO-220AB Part Marking Information

EXAMPLE : THIS IS AN IRF1010
WITH ASSEMBLY
LOT CODE 9B1M



International
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Data and specifications subject to change without notice. 6/00